

MOSFET

OptiMOS[™]3 Power-Transistor, 80 V

Features

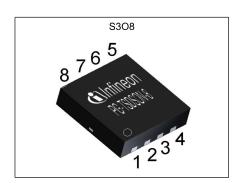
Package

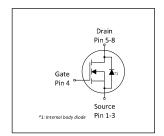
- Optimized technology for DC/DC converters
 Excellent gate charge x R_{DS(on)} product (FOM)
 Superior thermal resistance
- N-channel, normal level

- 100% avalanche tested
 Pb-free plating; RoHS compliant
 Qualified according to JEDEC¹⁾ for target applications
 Halogen-free according to IEC61249-2-21



| Table 1 Rey 1 circimanee 1 arameters | | | | | | | |
|--------------------------------------|-------|------|--|--|--|--|--|
| Parameter | Value | Unit | | | | | |
| V _{DS} | 80 | V | | | | | |
| R _{DS(on),max} | 12.3 | mΩ | | | | | |
| I _D | 56 | A | | | | | |











| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|-------------|---------|---------------|
| BSZ123N08NS3 G | PG-TSDSON-8 | 123N08N | - |



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

| Danamatan | Comple all | Values | | | | N | |
|---|--------------------------|--|------|-----------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Continuous drain current ¹⁾ I_D - - 35 A V_{GS} =10 V, T_C = | | V _{GS} =10 V, T _C =25 °C V _{GS} =10 V, T _C =100 °C V _{GS} =10 V, T _A =25 °C, R _{thJA} =60 K/W ²⁾ | | | | | |
| Pulsed drain current ³⁾ | I _{D,pulse} | - | - | 224 | Α | T _C =25 °C | |
| Avalanche energy, single pulse | Eas | - | - | 110 | mJ | $I_{\rm D}$ =20 A, $R_{\rm GS}$ =25 Ω | |
| Gate source voltage | V _{GS} | -20 | - | 20 | V | - | |
| Power dissipation | P_{tot} | - | - | 66 2.1 | W | T _C =25 °C T _A =25 °C, R _{thJA} =60 K/W ²⁾ | |
| Operating and storage temperature | $T_{\rm j},~T_{\rm stg}$ | -55 | - | 150 | °C | IEC climatic category; DIN IEC 68-1: 55/150/56 | |

2 Thermal characteristics

Thermal characteristics Table 3

| Doromotor | Symbol | Values | | | Limit | Note / Test Condition | |
|--|-------------------|--------|------|------|-------|-----------------------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Thermal resistance, junction - case | R _{thJC} | - | - | 1.9 | K/W | - | |
| Device on PCB, 6 cm ² cooling area ²⁾ | R_{thJA} | - | - | 60 | K/W | - | |

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.
²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 μm thick) copper area for drain

connection. PCB is vertical in still air.

3) See figure 3 for more detailed information



Electrical characteristics

at T_j=25 °C, unless otherwise specified

Static characteristics Table 4

| Danamatan | C | | Values | | | N. 4. 7. 4. 6. 4. 199 | |
|----------------------------------|--|------|--------------|---|------|---|--|
| Parameter | Symbol | Min. | | | Unit | Note / Test Condition | |
| Drain-source breakdown voltage | V _{(BR)DSS} | 80 | - | - | V | V _{GS} =0 V, I _D =1 mA | |
| Gate threshold voltage | ate threshold voltage $V_{GS(th)}$ 2 2.8 3.5 V | | V | $V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=33\ \mu {\rm A}$ | | | |
| Zero gate voltage drain current | I _{DSS} | - | 0.1 10 | 1 100 | μΑ | V _{DS} =80 V, V _{GS} =0 V, T _j =25 °C V _{DS} =80 V, V _{GS} =0 V, T _j =125 °C | |
| Gate-source leakage current | I _{GSS} | - | 10 | 100 | nA | V _{GS} =20 V, V _{DS} =0 V | |
| Drain-source on-state resistance | R _{DS(on)} | - | 10.3 13.9 | 12.3 24 | mΩ | V _{GS} =10 V, I _D =20 A V _{GS} =6 V, I _D =10 A | |
| Gate resistance | R _G | - | 2 | - | Ω | - | |
| Transconductance | g_{fs} | 17 | 34 | - | S | V _{DS} >2 I _D R _{DS(on)max} , I _D =20 A | |

Table 5 **Dynamic characteristics**

| Danamatan | Common of | | Values | | | N |
|----------------------------------|------------------|------|--------|------|------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Input capacitance ¹⁾ | C _{iss} | - | 1300 | 1700 | pF | V _{GS} =0 V, V _{DS} =40 V, f=1 MHz |
| Output capacitance ¹⁾ | Coss | - | 350 | 470 | pF | V _{GS} =0 V, V _{DS} =40 V, f=1 MHz |
| Reverse transfer capacitance | C _{rss} | - | 15 | - | pF | V _{GS} =0 V, V _{DS} =40 V, f=1 MHz |
| Turn-on delay time | $t_{\sf d(on)}$ | - | 12 | - | ns | $V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G}$ =1.6 Ω |
| Rise time | t _r | - | 18 | - | ns | $V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G}$ =1.6 Ω |
| Turn-off delay time | $t_{ m d(off)}$ | - | 19 | - | ns | $V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G}$ =1.6 Ω |
| Fall time | t _f | - | 4 | - | ns | $V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G}$ =1.6 Ω |

Table 6 Gate charge characteristics²⁾

| Parameter | Cumbal | Values | | | Unit | Note / Took Condition | |
|---------------------------------|----------------------|--------|------|------|------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Gate to source charge | Q _{gs} | - | 6.3 | - | nC | V_{DD} =40 V, I_{D} =20 A, V_{GS} =0 to 10 V | |
| Gate charge at threshold | Q _{g(th)} | - | 3.6 | - | nC | V_{DD} =40 V, I_{D} =20 A, V_{GS} =0 to 10 V | |
| Gate to drain charge | Q _{gd} | - | 3.8 | - | nC | V _{DD} =40 V, I _D =20 A, V _{GS} =0 to 10 V | |
| Switching charge | Q _{sw} | - | 6.5 | - | nC | V _{DD} =40 V, I _D =20 A, V _{GS} =0 to 10 V | |
| Gate charge total ¹⁾ | Q_g | - | 19 | 25 | nC | V_{DD} =40 V, I_{D} =20 A, V_{GS} =0 to 10 V | |
| Gate plateau voltage | V _{plateau} | - | 4.9 | - | V | V_{DD} =40 V, I_{D} =20 A, V_{GS} =0 to 10 V | |
| Output charge ¹⁾ | Qoss | - | 25 | 34 | nC | V _{DD} =40 V, V _{GS} =0 V | |

Defined by design. Not subject to production test See "Gate charge waveforms" for parameter definition

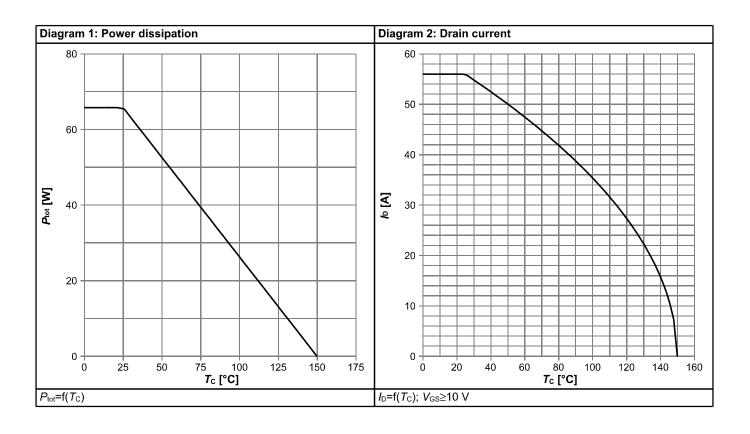


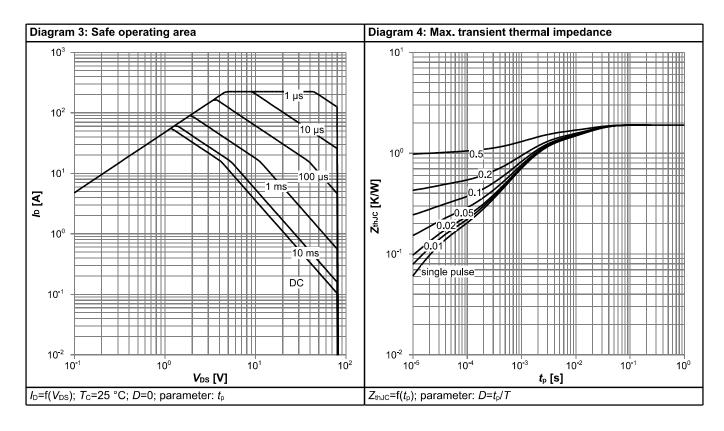
Table 7 Reverse diode

| Develope | Course had | | Values | | | N 4 / T 4 2 | |
|----------------------------------|----------------------|------|--------|------|------|--|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Diode continuous forward current | Is | - | - | 47 | Α | T _C =25 °C | |
| Diode pulse current | I _{S,pulse} | - | - | 224 | Α | T _C =25 °C | |
| Diode forward voltage | V _{SD} | - | 0.89 | 1.2 | V | V _{GS} =0 V, I _F =20 A, T _j =25 °C | |
| Reverse recovery time | t _{rr} | _ | 45 | - | ns | V _R =40 V, I _F =20A, dI _F /dt=100 A/μs | |
| Reverse recovery charge | Q _{rr} | _ | 54 | - | nC | V _R =40 V, I _F =20A, d <i>i</i> _F /d <i>t</i> =100 A/μs | |

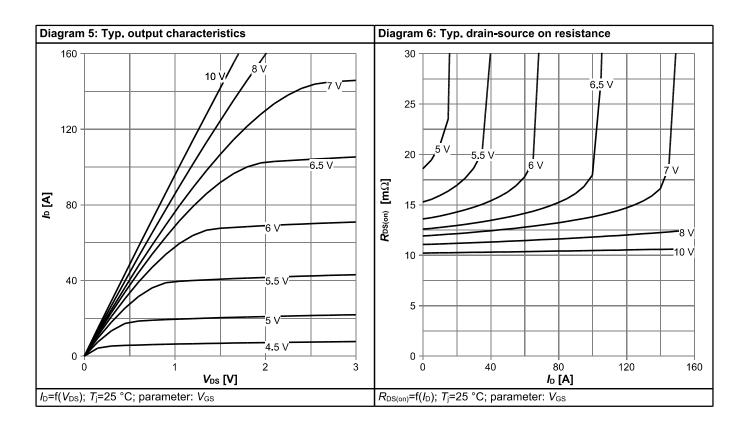


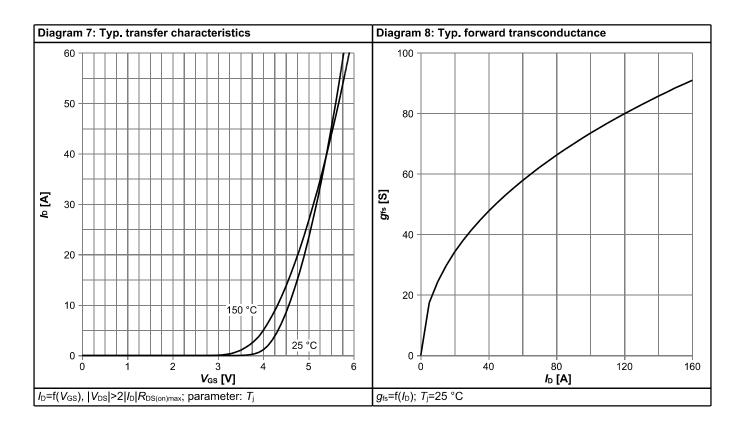
4 Electrical characteristics diagrams



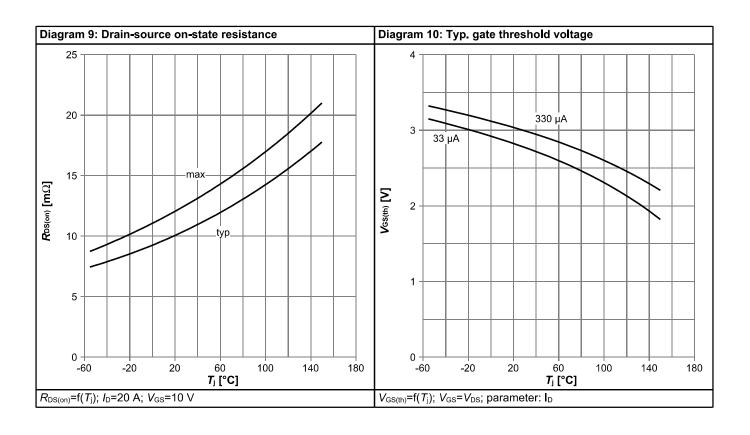


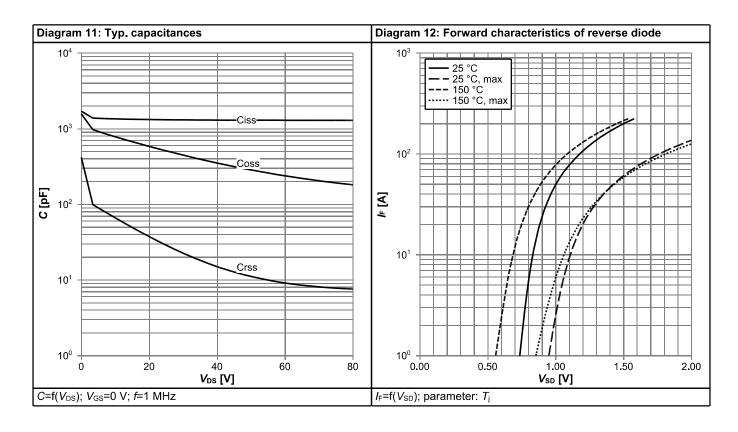




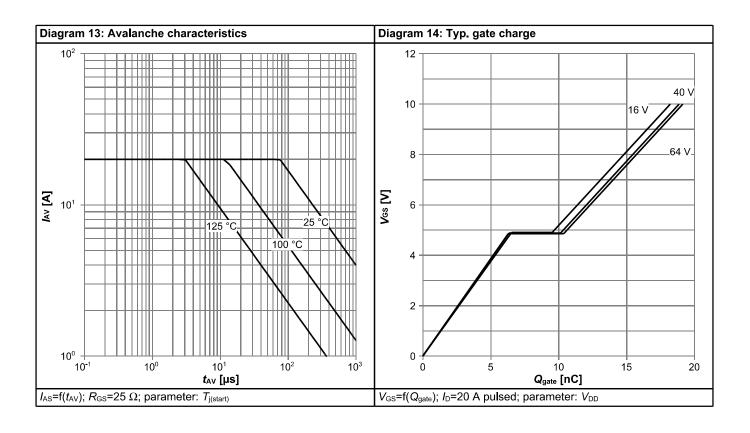


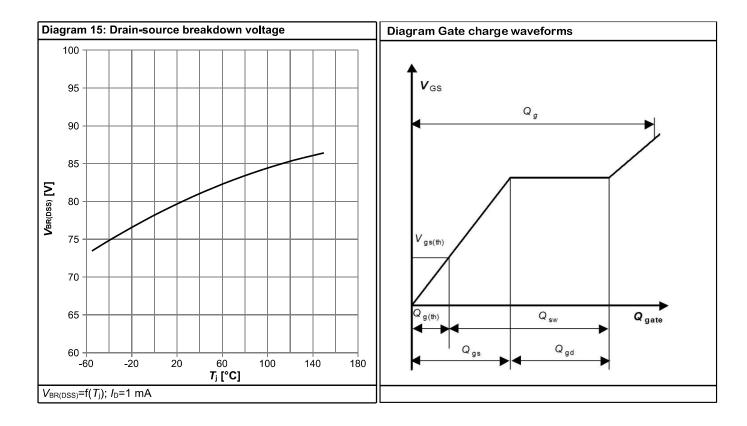






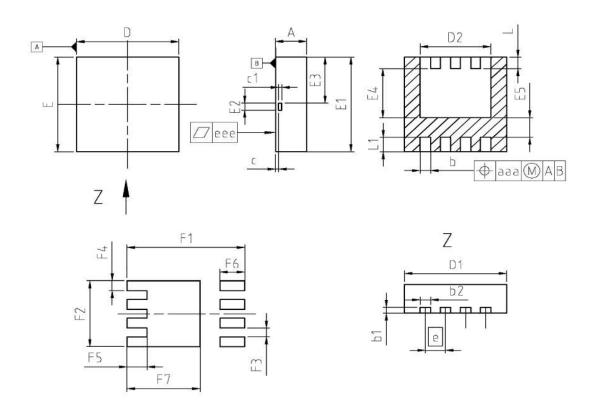








5 Package Outlines



| | MILLIN | INC | HES | | |
|------|--------|------|-------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| A | 0.95 | 1.00 | 0.037 | 0.039 | |
| b | 0.25 | 0.35 | 0.010 | 0.014 | |
| b1 | 0.10 | 0.30 | 0.004 | 0.012 | |
| b2 | 0.20 | 0.40 | 0.008 | 0.016 | |
| c | 0.00 | 0.20 | 0.000 | 0.008 | |
| D-D1 | 3.20 | 3.40 | 0.126 | 0.134 | |
| D2 | 2.15 | 2.35 | 0.085 | 0.093 | |
| E=E1 | 3.20 | 3.40 | 0.126 | 0.134 | |
| E2 | 0.10 | 0.30 | 0.004 | 0.012 | |
| E3 | 1.35 | 1.55 | 0.053 | 0.061 | |
| E4 | 1.60 | 1.80 | 0.063 | 0.071 | |
| E5 | 0.66 | 0.86 | 0.026 | 0.034 | |
| | 0.60 | 0.70 | 0.024 | 0.028 | |
| N | | 8 | | 8 | |
| L | 0.31 | 0.51 | 0.012 | 0.020 | |
| L1 | 0.33 | 0.53 | 0.013 | 0.021 | |
| aaa | 0.2 | 25 | 0.0 | 10 | |
| 600 | 0.0 |)5 | 0.002 | | |
| F1 | 3.70 | 3.90 | 0.146 | 0.154 | |
| F2 | 2.19 | 2.39 | 0.086 | 0.094 | |
| F3 | 0.21 | 0.41 | 0.008 | 0.016 | |
| F4 | 0.24 | 0.44 | 0.009 | 0.017 | |
| F5 | 0.55 | 0.75 | 0.022 | | |
| F6 | 0.70 | 0.90 | 0.028 | 0.035 | |
| F7 | 2.26 | 2.46 | 0.089 | 0.097 | |

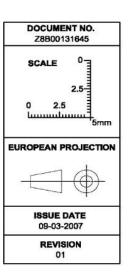


Figure 1 Outline PG-TSDSON-8, dimensions in mm/inches



Revision History

BSZ123N08NS3 G

Revision: 2021-12-16, Rev. 2.5

| Previous Revision | | | | | | |
|-------------------|------------|--|--|--|--|--|
| Revision | Date | Subjects (major changes since last revision) | | | | |
| 2.5 | 2021-12-16 | Update current rating and Vsd typ | | | | |

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